# IGBT - Field Stop II / 4 Lead

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop II Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss. In addition, this new device is packaged in a TO-247-4L package that provides significant reduction in Eon Losses compared to standard TO-247-3L package. The IGBT is well suited for UPS and solar applications. Incorporated into the device is a soft and fast co-packaged free wheeling diode with a low forward voltage.

#### Features

- Extremely Efficient Trench with Field Stop Technology
- $T_{Jmax} = 175^{\circ}C$
- Improved Gate Control Lowers Switching Losses
- Separate Emitter Drive Pin
- TO-247-4L for Minimal E<sub>on</sub> Losses
- Optimized for High Speed Switching
- These are Pb–Free Devices

#### **Typical Applications**

- Solar Inverter
- Uninterruptible Power Inverter Supplies (UPS)
- Neutral Point Clamp Topology

#### **ABSOLUTE MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
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Collector-emitter voltage	V <sub>CES</sub>	650	V
Collector current @ Tc = 25°C @ Tc = 100°C	Ι <sub>C</sub>	200 75	A
Diode Forward Current @ Tc = 25°C @ Tc = 100°C	IF	200 75	A
Diode Pulsed Current T <sub>PULSE</sub> Limited by T <sub>J</sub> Max	I <sub>FM</sub>	200	A
Pulsed collector current, T <sub>pulse</sub> limited by T <sub>Jmax</sub>	I <sub>CM</sub>	200	A
Gate-emitter voltage	V <sub>GE</sub>	±20	V
Transient gate–emitter voltage ( $T_{PULSE}$ = 5 µs, D < 0.10)		±30	V
Power Dissipation @ Tc = 25°C @ Tc = 100°C	P <sub>D</sub>	536 268	W
Operating junction temperature range	Τ <sub>J</sub>	-55 to +175	°C
Storage temperature range	T <sub>stg</sub>	-55 to +175	°C
Lead temperature for soldering, 1/8" from case for 5 seconds	T <sub>SLD</sub>	260	°C

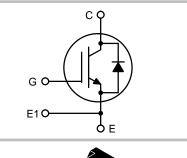
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

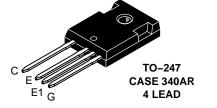


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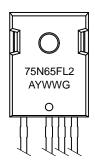
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75 A, 650 V V<sub>CEsat</sub> = 1.70 V  $E_{on} = 0.61 \text{ mJ}$ 





#### MARKING DIAGRAM



75N65FL2 = Specific Device Code = Assembly Location А Υ

- = Year
- WW = Work Week G
  - = Pb-Free Package

#### **ORDERING INFORMATION**

Device	Package	Shipping
NGTB75N65FL2WAG	TO–247 (Pb–Free)	30 Units / Rail

#### THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ ext{ heta}JC}$	0.28	°C/W
Thermal resistance junction-to-case, for Diode	$R_{ hetaJC}$	0.62	°C/W
Thermal resistance junction-to-ambient	$R_{ hetaJA}$	40	°C/W

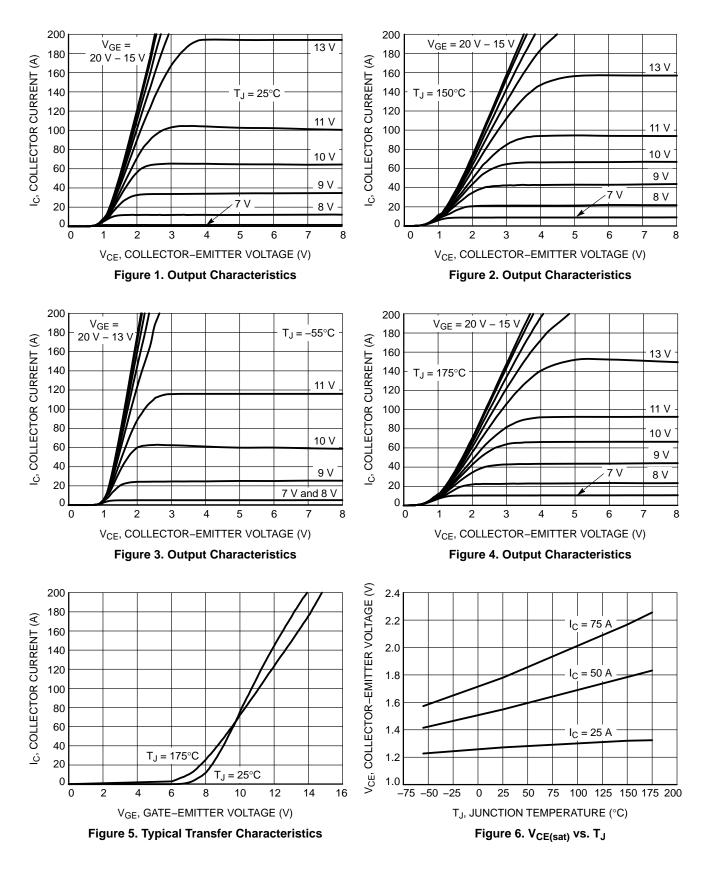
#### **ELECTRICAL CHARACTERISTICS** (T<sub>1</sub> = 25°C unless otherwise specified)

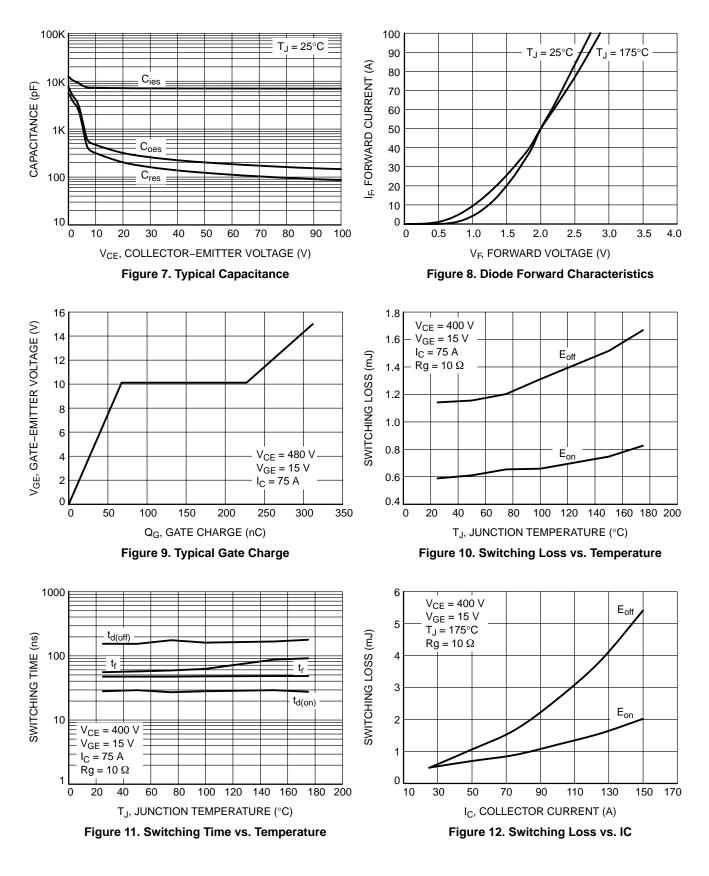
Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC	·			•		
Collector-emitter breakdown voltage, gate-emitter short-circuited	$V_{GE}$ = 0 V, I <sub>C</sub> = 500 µA	V <sub>(BR)CES</sub>	650	-	-	V
Collector-emitter saturation voltage	V <sub>GE</sub> = 15 V, I <sub>C</sub> = 75 A V <sub>GE</sub> = 15 V, I <sub>C</sub> = 75 A, T <sub>J</sub> = 175°C	V <sub>CEsat</sub>	1.50 -	1.70 2.30	2.00	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}, I_C = 350 \ \mu A$	V <sub>GE(th)</sub>	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	$V_{GE} = 0 V, V_{CE} = 650 V$ $V_{GE} = 0 V, V_{CE} = 650 V, T_{J} = 175^{\circ}C$	I <sub>CES</sub>		_ 7.0	0.3 -	mA
Gate leakage current, collector-emitter short-circuited	$V_{GE} = 20 \text{ V}$ , $V_{CE} = 0 \text{ V}$	I <sub>GES</sub>	_	-	200	nA
DYNAMIC CHARACTERISTIC	·					
Input capacitance	V <sub>CE</sub> = 20 V, V <sub>GE</sub> = 0 V, f = 1 MHz	Cies	-	7200	-	pF
Output capacitance		C <sub>oes</sub>	-	300	-	
Reverse transfer capacitance		C <sub>res</sub>	-	200	-	
Gate charge total	V <sub>CE</sub> = 480 V, I <sub>C</sub> = 75 A, V <sub>GE</sub> = 15 V	Qg	-	310	-	nC
Gate to emitter charge		Q <sub>ge</sub>	-	60	-	
Gate to collector charge	]	Q <sub>gc</sub>	-	160	-	
SWITCHING CHARACTERISTIC, INDUC	TIVE LOAD					
Turn-on delay time		t <sub>d(on)</sub>	-	23	-	ns
Rise time	1	t <sub>r</sub>	-	50	-	
Turn-off delay time	T <sub>J</sub> = 25°C	t <sub>d(off)</sub>	-	157	-	
Fall time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 75 \text{ A}$ $R_{g} = 10 \Omega$	t <sub>f</sub>	-	55	-	
Turn-on switching loss	$V_{GE} = 15 V$	Eon	-	0.61	-	mJ
Turn-off switching loss		E <sub>off</sub>	-	1.2	-	
Total switching loss		E <sub>ts</sub>	-	1.81	-	
Turn-on delay time	$T_{J} = 175^{\circ}C$ $V_{CC} = 400 \text{ V}, \text{ I}_{C} = 75 \text{ A}$ $R_{g} = 10 \Omega$ $V_{GE} = 15 \text{ V}$	t <sub>d(on)</sub>	-	28	-	ns
Rise time		t <sub>r</sub>	-	50	-	
Turn-off delay time		t <sub>d(off)</sub>	-	172	-	
Fall time		t <sub>f</sub>	-	90	-	
Turn-on switching loss		Eon	-	0.85	-	mJ
Turn-off switching loss		E <sub>off</sub>	-	1.8	-	
Total switching loss	-	E <sub>ts</sub>	_	2.65	_	

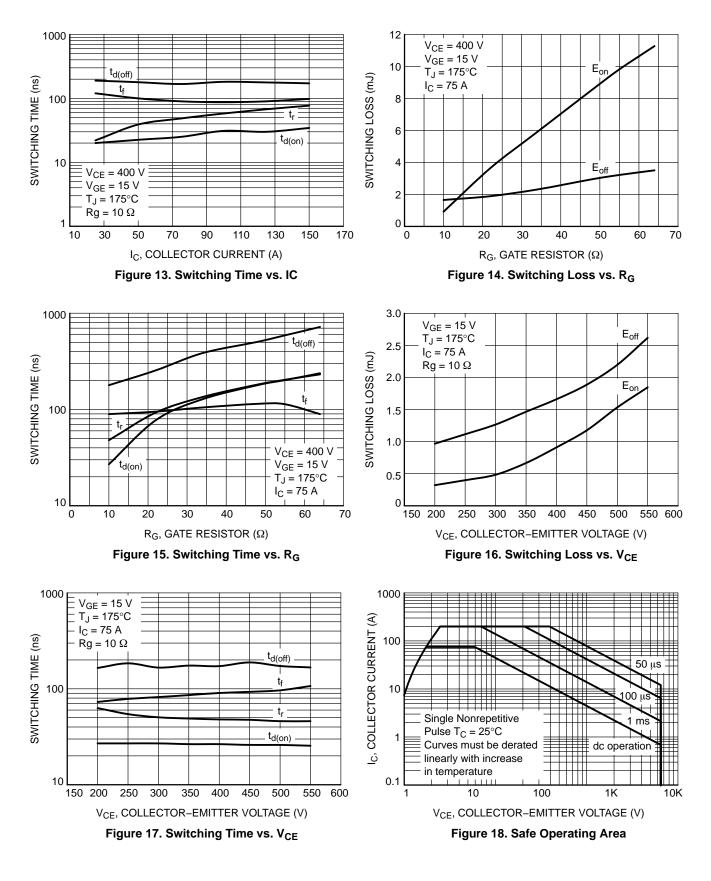
#### **DIODE CHARACTERISTIC**

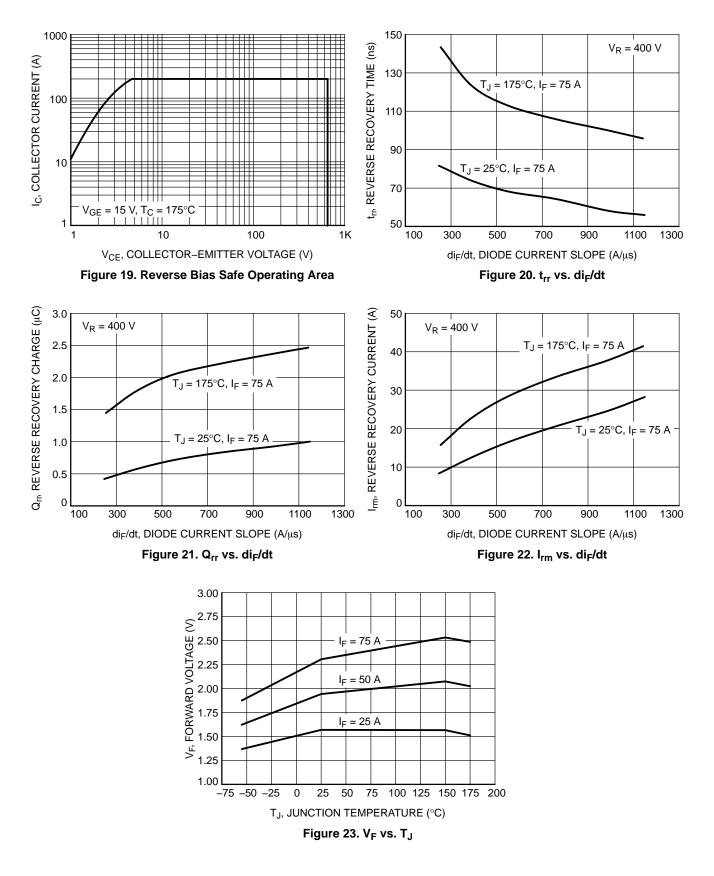
Forward voltage	V <sub>GE</sub> = 0 V, I <sub>F</sub> = 75 A V <sub>GE</sub> = 0 V, I <sub>F</sub> = 75 A, T <sub>J</sub> = 175°C	V <sub>F</sub>	1.50 -	2.30 2.50	2.90 -	V
Reverse recovery time	T.I = 25°C	t <sub>rr</sub>	-	90	-	ns
Reverse recovery charge	I <sub>F</sub> = 75 Å, V <sub>R</sub> = 200 V	Q <sub>rr</sub>	-	0.40	-	μC
Reverse recovery current	di <sub>F</sub> /dt = 200 A/µs	I <sub>rrm</sub>	-	7.0	-	А
Reverse recovery time	T <sub>J</sub> = 175°C	t <sub>rr</sub>	-	173	-	ns
Reverse recovery charge	I <sub>F</sub> = 75 A, V <sub>R</sub> = 200 V	Q <sub>rr</sub>	-	1.47	-	μC
Reverse recovery current	di <sub>F</sub> /dt = 200 A/μs	I <sub>rrm</sub>	-	13	_	Α

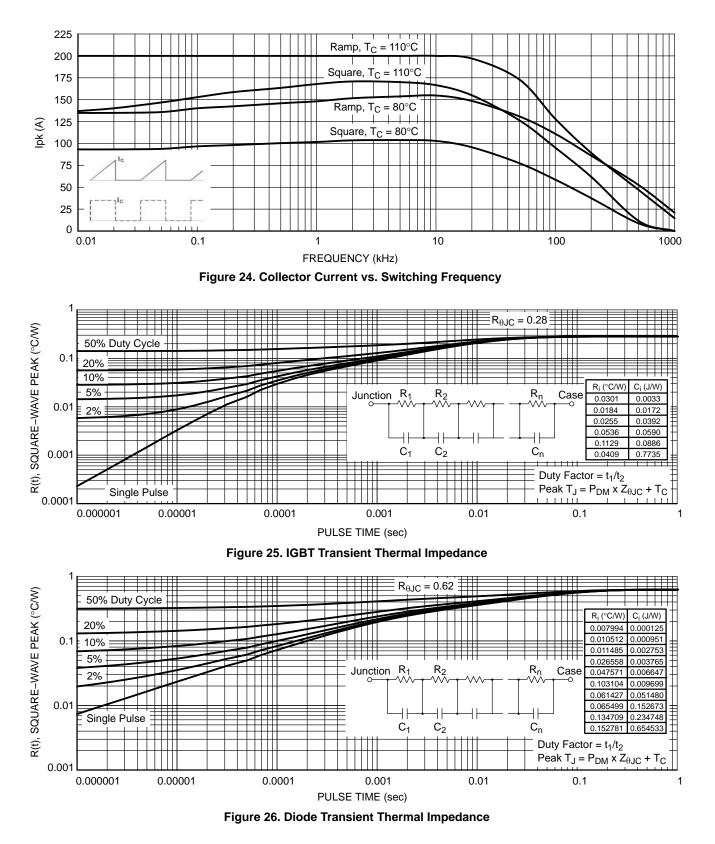
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.











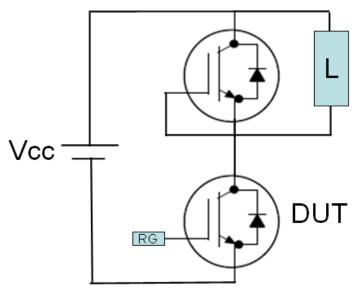
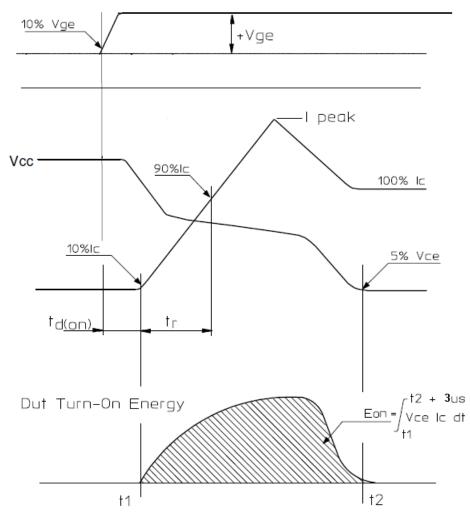
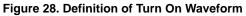
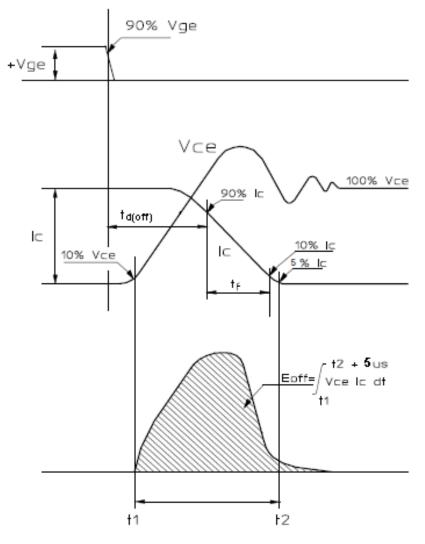
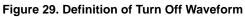


Figure 27. Test Circuit for Switching Characteristics



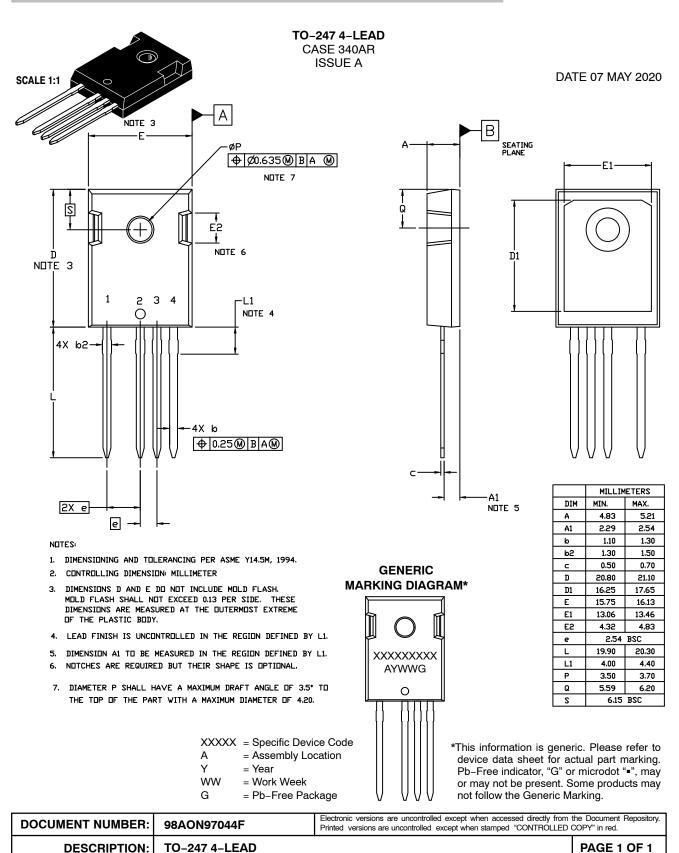






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